# **Development of High-Density Silicon Photomultipliers at NDL**

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April 29, 2019

**CEPC MOST2 at IHEP** 

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- Summary

# Motivation

• Scientific Researches, such as hadronic calorimeter (HCAL), electromagnetic calorimeter (ECAL), or SciFi tracker in high energy physics, need huge amount of SiPMs with large dynamic range, , or highly resolved imaging with fewer readout channels



LHCb **SciFi tracker** with 1-D pixel SiPM array [NIM A, 2017]

NIM A789(2015)158 - 164

SiPMs for CMS **HCAL** 

# **Features of NDL SiPMs**



#### Features

• In contrast to conventional SiPMs that quenching resistors are fabricated at device surface, the bulk resistor under each APD cell in the epitaxial layer is used as the quenching resistors

#### Advantages

- Small micro cell, high micro cell density (thus large dynamic range) while retaining high fill factor and photon detection efficiency (PDE)
- No extra fabrication processes for quenching resistors are needed, thus simple fabrication technology and cost effective.

#### **Results--**Pulse Area spectrum and Gain

#### $1 \times 1 \text{ mm}^2 \text{EQR SiPM}$ with pitch of $10 \,\mu\text{m}$



It can distinguish at least **15p.e.** under overvoltage close to 5V at 20°C.

Gain at 6V overvoltage is about  $2.1 \times 10^5$ .

## **Results**—pde



 1×1 mm<sup>2</sup> NDL SiPM with pitch of 10 μm under 7V overvoltage at 20°C.

- (a) Measured PDE as a function of waveform by photon counting method at different overvoltage.
- (b), (c) and (d) is measured
   by three methods at
   420nm,470nm and 530nm.

Photon Counting Method
 Modified Photon Counting Method
 Poisson Method

### **Results--**Correlated Noise



- The scatter plot analysis and the histogram distribution versus the time interval for dark pulses of  $1 \times 1 \text{ mm}^2$  NDL SiPM with pitch of 10 µm under 7 V overvoltage at -30°C.
- The direct crosstalk probability and the delayed-correlated-noise probability was **7.6%** and **3.0%** respectively.

#### **Results--** recovery time



The recovery time of  $3 \times 3 \text{ mm}^2$  NDL EQR SiPM with pitch of 10 µm obtained by performing the noise scatter plot analysis (left) and the fitting for pulse falling edge (right) is **4.0 ns and 3.7 ns** respectively.

#### **Results--** recovery time



The recovery time of  $1 \times 1 \text{ mm}^2$  NDL SiPM with pitch of 10 µm obtained by performing the noise scatter plot analysis (left) and the fitting for pulse falling edge (right) is 2.2 ns.

### **Results**— SPTR and Dynamic Range

The EQR SiPM has a size of  $1 \times 1 \text{ mm}^2$  with pitch of  $10 \mu \text{m}$ .



approximately 60 ps at 6 V overvoltage.

The dynamic range reaches about  $10^4$ .

### **Results**— NDL SiPM with other geometrical parameter



### **Results**— NDL SiPM with other geometrical parameter



# **1mm×1mm N-ON-P type Test Sample**, Cell diameter $5\mu$ m with gap 2 $\mu$ m, Total **21488** micro cells



#### High Density SiPM: SensL, Hamamatsu VS NDL

	NDL SiPM		SensL SiPM		Hamamatsu MPPC	
Effective Active	11-3030 C-S/T	11-1010 C-S/T	C-30020-SMT	C-10010-SMT	S12572-010-C/P	S12571-010-C/P
Area	3.0×3.0 mm <sup>2</sup>	1.0×1.0 mm <sup>2</sup>	3.0×3.0 mm <sup>2</sup>	$1.0  imes 1.0  { m mm^2}$	$3.0 \times 3.0 \text{ mm}^2$	1.0 imes1.0 mm <sup>2</sup>
<b>Effective Pitch</b>	10 µm	10 µm	28 μm	18 μm	10 µm	10 µm
Micro-cell Number	90000	10000	10998	2880	90000	10000
Fill Factor	40%	40%	48%	28%	33%	33%
Breakdown Voltage (V <sub>b</sub> )	27.5±0.4V	27.5±0.4V	24.2-24.7	24.2-24.7	65±10V	$65\pm10V$
Measurement Overvoltage (V)	5	5	2.5	2.5	4.5	4.5
Peak PDE	31%@420nm	31%@420nm	24%@420nm	14%@420nm	10%@470nm	10%@470nm
Max. Dark Count (kcps)	~6000	~500	860	96	2000	200
Gain	2×10 <sup>5</sup>	2×10 <sup>5</sup>	1×10 <sup>6</sup>	2×10 <sup>5</sup>	1.35×10 <sup>5</sup>	$1.35 \times 10^{5}$
Temp. Coef. For V <sub>b</sub>	<b>25mV/</b> ℃	<b>25mV/</b> ℃	<b>21.5mV/</b> ℃	<b>21.5mV/</b> ℃	<b>60mV/</b> ℃	<b>60mV/</b> ℃

#### NDL-11-1010C SiPM Readout by KlauS ASIC



#### **Provided by the KIP, Heidelberg University**

KlauS5: A 36-channel low power silicon photomultiplier charge readout ASIC

#### **Road Map of NDL SiPMs for CEPC HCAL & ECAL**

	Expected NDL SiPM for ECAL	Existed NDL SiPM		Expected NDL SiPM for HCAL
Effective Pitch	6 μm	10 µm	12.5 μm	14 μm
Micro-cell Number/mm <sup>2</sup>	27650	10000	6400	5040
Fill Factor	34%	40%	52%	56%
Breakdown Voltage (V <sub>b</sub> )	24.0±0.1V	27.5±0.4V	27.5±0.4V	24.0±0.1V
Peak PDE	26%@420nm	31%@420nm	~31%@420nmª	43%@420nm
Dark Count (kcps/mm <sup>2</sup> )	<500	~500	~500	<500
Gain	6.0×10 <sup>4</sup>	2.0×10 <sup>5</sup> @6V	4.5×10 <sup>5</sup> @5V	6.0×10 <sup>5</sup>
Temp. Coef. For V <sub>b</sub>	<b>25mV/</b> ℃	<b>25mV/</b> ℃	<b>25mV/</b> ℃	<b>25mV/</b> ℃

<sup>a</sup> anti-reflection coating was not optimized for 420 nm, so it was not expected as 40%

# Summary

- NDL has been developing an unusual SiPM technology, epitaxial quenching resistor (EQR) type SiPM. It features:
- Small micro cell, high micro cell density (thus large dynamic range) while retaining high fill factor and photon detection efficiency (PDE) → alleviate the contradiction between dynamic range and PDE encountered by a usual SiPM
- ➢No extra quenching resistors fabrication steps, thus simple fabrication technology and cost effective.
- It is very suitable for applications such as scientific researches (e.g., HCAL & ECAL), safety & security, preclinical PET and small animal PET etc.

### **Thank You for Your Attentions!**

We strongly hope to join CEPC so that we can understand its exact needs promptly and serve it whole-heartedly.

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